

# **OLED DISPLAY MODULE**

# **Product Specification**

CUSTOMER	Standard	
PRODUCT NUMBER	DD-2C20WE-1A	
CUSTOMER APPROVAL		Date

INTERNAL APPROVALS			
Product Mgr	Doc. Control	Electr. Eng	
Bazile Bazile Peter Peter		Luo	
Peter	Peter	Luo	



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# REVISION RECORD

Rev.	Date	Page	Chapt.	Comment	ECR no.
A	21 Mar 11			First Issue	
В	28 Nov 12	42	10	Update the connector information	

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# 1 MAIN FEATURES

ITEM	CONTENTS
Characters x lines	20 x 2
Character Font	5 x 8
Overall Dimensions	84.50 x 19.28 x 2.00 mm
Colour	Monochrome White
Active Area	73.52 x 11.52 mm
Viewing Area	75.52 x 13.52 mm
Display Mode	Passive Matrix (2.93")
Driving Method	1/16 duty
Driver IC	US2066
Operating temperature	-40 ~ +85
Storage temperature	-40 ~ +90

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# **2 MECHANICAL SPECIFICATION**

# 2.1 MECHANICAL CHARACTERISTICS

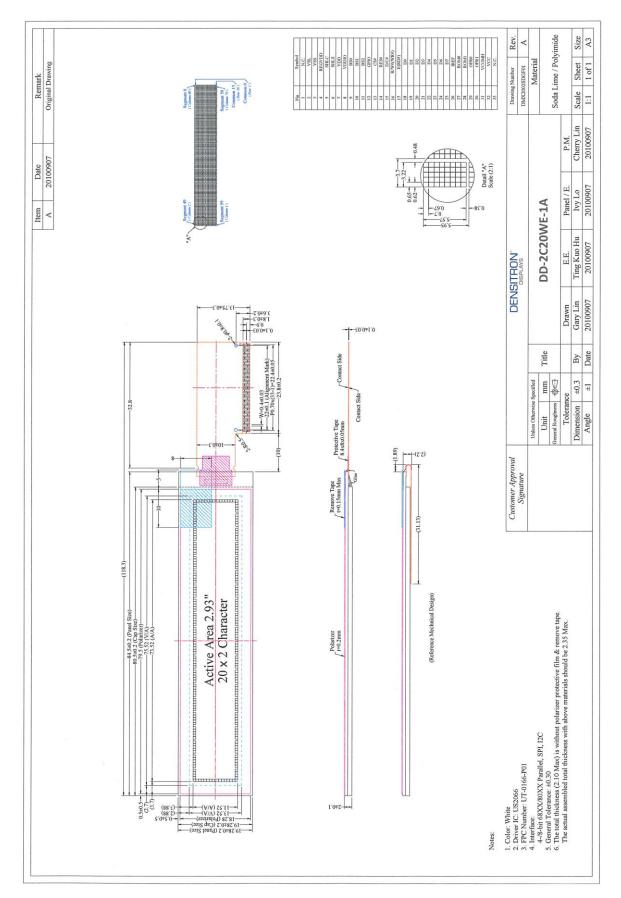
ITEM	CHARACTERISTIC	UNIT
Characters x lines	20 x 2	
Overall Dimensions	84.50 x 19.28 x 2.00	mm
Viewing Area	75.52 x 13.52	mm
Active Area	73.52 x 11.52	mm
Dot Size	0.62 x 0.67	mm
Dot Pitch	0.65 x 0.70	mm
Character size	3.22 x 5.57	mm
Weight	7.01	g
IC Controller/Driver	US2066	<u>.</u>

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# 2.2 MECHANICAL DRAWING



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## 3 ELECTRICAL SPECIFICATION

### 3.1 ABSOLUTE MAXIMUM RATINGS

VSS = 0 V, Ta = 25 °C

Item	Symbol	Min	Max	Unit	Note
Supply Voltage for logic	$V_{\mathrm{DD}}$	-0.3	6.0	V	
Supply Voltage for I/O Pins	Voltage for I/O Pins V <sub>DDIO</sub>		6.0	V	Note 1, 2
Supply voltage for Display	Vcc	0	15	V	
Operating Temperature	Тор	-40	85	°C	Note 3
Storage Temperature	Tst	-40	90	°C	Note 3
Life Time (120 cd/m2)		30,000	-	hour	Note 4

- Note 1: All the above voltages are on the basis of "VSS=0V".
- Note 2: When this module is used beyond the above absolute maximum ratings, permanent damage to the module may occur. Also for normal operations it's desirable to use this module under the conditions according to Section 3.2 "Electrical Characteristics". If this module is used beyond these conditions the module may malfunction and the reliability could deteriorate.
- Note 3: The defined temperature ranges do not include the polarizer. The maximum withstood temperature of the polarizer should be 80°C.
- Note 4: Vcc =12.0V, Ta=25 °C, 50% Checkerboard. Software configuration follows Section 5.4 Actual Application Example End of lifetime is specified as 50% of initial brightness reached. The average operating lifetime at room temperature is estimated by the accelerated operation at high temperature conditions.



## 3.2 ELECTRICAL CHARACTERISTICS

Characteristics	Symbol	Conditions	Min	Тур	Max	Unit
Supply Voltage for Logic	V	5V I/O Application	-	-	-	V
Supply Voltage for Logic	$V_{ m DD}$	Low Voltage I/O Application	2.4	2.8	$V_{\mathrm{DDIO}}$	V
Supply Voltage for I/O	V	5V I/O Application	4.4	5.0	5.5	V
Supply Voltage for 1/O	$V_{ m DDIO}$	Low Voltage I/O Application	2.4	2.8	3.6	V
Supply Voltage for Display	$V_{CC}$	Note 1	11.5	12	12.5	V
High Level Input	$V_{IH}$	IOUT=0.1mA,	$0.8 \mathrm{x} \mathrm{V}_{\mathrm{DDIO}}$	-	$V_{ m DDIO}$	V
Low Level Input	$V_{IL}$	3.3MHz	0	-	0.2 x VDDIO	V
High Level Output	$V_{OH}$	IOUT=0.1mA,	0.9 x VDDIO	-	VDDIO	V
Low Level Output	$V_{OL}$	3.3MHz	0	-	0.1 x V <sub>DDIO</sub>	V
Operating current for VDD	Idd	-	1	180	300	μΑ
		Note 2	-	13.5	17.0	
Operating current for Vcc	Icc	Note 3	-	21.1	25.8	mA
		Note 4	-	40	48	
Sleep mode current for VDD	Idd Sleep		-	1	10	μΑ
Sleep mode current for Vcc	ICC SLEEP		-	2	10	μA

Note 1: Brightness (Lbr) and Supply Voltage for Display (VCC), are subject to the change of the panel characteristics

Note 2:  $V_{DD} = 2.8V$ ,  $V_{CC} = 12.0V$ , 30% display area turned on.

Note 2:  $V_{DD} = 2.8V$ ,  $V_{CC} = 12.0V$ , 50% display area turned on.

Note 4:  $V_{DD} = 2.8V$ ,  $V_{CC} = 12.0V$ , 100% display area turned on.

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# 3.3 INTERFACE PIN ASSIGNMENT

No.	Symbol	I/O	Function	
1	N.C.(GND)	-	Reserved Pin (Supporting Pin) The supporting pin can reduce the influence from stress on the function pins. This pin must be connected to external ground	
2	VSL	P	Segment Voltage Reference Pin When external VSL is not used, this pin should be left open. When external VSL is used, connect with resistor and diode to ground.	
3	VSS	P	Ground of Logic Circuit This is a ground pin. It also acts as a reference for the logic pins, the OEL driving voltages and the analogue circuits. It must be connected to external ground.	
4	REGVDD	I	Internal VDD Regulator Selection Pin When this pin is pulled HIGH, internal VDD regulator is enabled (VDD outputs 3.3V). When this pin is pulled LOW, internal VDD regulator is disabled (VDD outputs 5V).	
5	SHLC	I	COM Scan Direction Selection This pin is used to determine the Common output scanning direction  SHLC COM scan direction  COM0 to COM31  COM31 to COM0	
6	SHLS	I	SEG Direction Selection This pin is used to determine the SEG direction SHLS SEG direction 0 SEG99 to SEG0 1 SEG0 to SEG99	
7	VDD	P	Power Supply for Logic This is a voltage supply pin. It can be supplied externally or regulated internally. In 3V IO mode, this is a power input pin. In 5V IO mode, the output is around 3.3V. A capacitor should be connected between VDD and VSS under all circumstances	
8	VDDIO	P	Power Supply for Interface Logic Level It should match with the MCU interface voltage level and must be connected to external source	
9	BS0		Communicating Protocol Select These pins are MCU interface selection input. See the following table:	
10	BS1	I	BS0         BS1         BS2           Serial Interface         0         0         0           Invalid         1         0         0           I2C         0         1         0	

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			Invalid	1	1	0	1
			8 bit 68XX-parallel	0	0	1	-
11	BS2		4 bit 68XX-parallel	1	0	1	=
11	D52		8 bit 80XX-parallel	0	1	1	=
			4 bit 80XX-parallel	1	1	1	
12	GPIO	I/O	It is a reserved pin and is recor	mmended to	o keep it flo	ating.	_
13	CS#	I	Chip Select This pin is the chip select inpucommunication only when CS			or MCU	
14	RES#	I	Power Reset for Controller an This pin is reset signal input. V of the chip is executed.		n is low, ini	tializatio	on
15	D/C#	I	Data/Command Control This is Data/Command control pin. When the pin is pulled high the input at D7~D0 is treated as display data. When the pin is pulled low, the input at D7~D0 will be transferred to the command register. For detail relationship to MCU interface signals, please refer to the Timing Characteristics Diagrams.  When the pin is pulled high and serial interface mode is selecte the data at SDIN is treated as data. When it is pulled low the data at SDIN will be transferred to the command register. In I2C mode, this pin acts as SA0 for slave address selection.		ed,		
16	R/W#	I	Read/Write Select or Write This pin is MCU interface inp 68XX-series microprocessor, Read/Write (R/W#) selection "High" for read mode and pul When 80XX interface mode is (WR#) input. Data write operating the CS# are pulled low.	this pin will input. Pull to "Low" s selected, the	be used as this pin to for write r	mode. be the Wi	
17	E/RD#	I	Read/Write Enable or Read This pin is MCU interface inp 68XX-series microprocessor, Enable (E) signal. Read/write is pulled high and the CS# is p When connecting to an 80XX the Read (RD#) signal. Data re pin is pulled low and CS# is p	this pin will operation is bulled low.  -microproceed operation	be used as sinitiated with	the hen this p	es
18~25	D0~D7	I/O	Host Data Input/Output Bus These pins are 8-bit bi-directic microprocessor's data bus. WI be the serial data input SDIN a input SCLK. When I2C mode together and serve as SDAout, the serial clock input SCL	hen serial m and D0 will is selected,	ode is select be the serial D2, D1 sho	ted, D1 v ll clock ould be tie	will ed

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26	IREF	I	Current Reference for Brightness Adjustment This pin is segment current reference pin. A resistor should be connected between this pin and VSS. Set the current at 12.5uA.		
27	ROM0		Character ROM Selection These pins are used to select Character ROM. See the following table:  ROM ROM0 ROM1		
28	ROM1	I	ROM   ROM1   ROM1   A		
29	OPR0		Select the number of Character Generator These pins are used to select Character number of character generator. See the following table:  CGROM CGRAM OPRO OPR1		
30	OPR1	I	256		
31	VCOMH	0	Voltage Output High Level for COM Signal This pin is the input pin for the voltage output high level for COM signals. A capacitor should be connected between this pin and VSS.		
32	VCC	P	Power Supply for OEL Panel This is the most positive voltage supply pin of the chip. A stabilization capacitor should be connected between this pin and VSS when the converter is used. It must be supplied externally.		
33	N.C.	-	Reserved Pin (Supporting Pin) The supporting pin can reduce the influence from stress on the function pins. This pin must be connected to external ground		

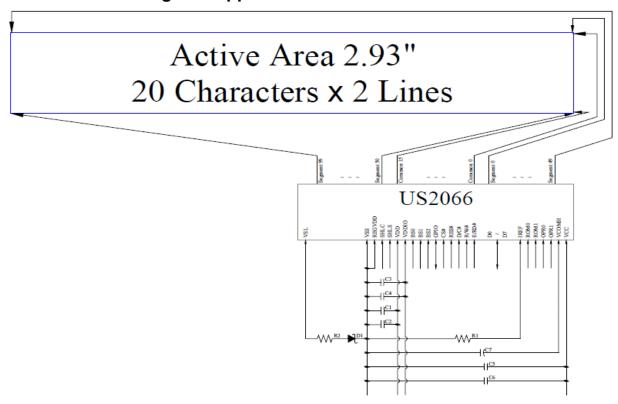
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#### 3.4 BLOCK DIAGRAM

## 3.4.1 Low Voltage I/O Application



MCU Interface Selection: BS0, BS1 and BS2

Pins connected to MCU interface: CS#, RES#, D/C#, R/W#, E/RD#, and D0~D7

\* SHLC, SHLC, ROM0, ROM1, OPR0 and OPR1 should be configured.

C1, C3, C5: 0.1µF C2, C4: 4.7µF C6: 10µF

C7: 4.7μF / 25V Tantalum Capacitor

R1: 470kΩ, R1 = (Voltage at IREF - VSS) / IREF

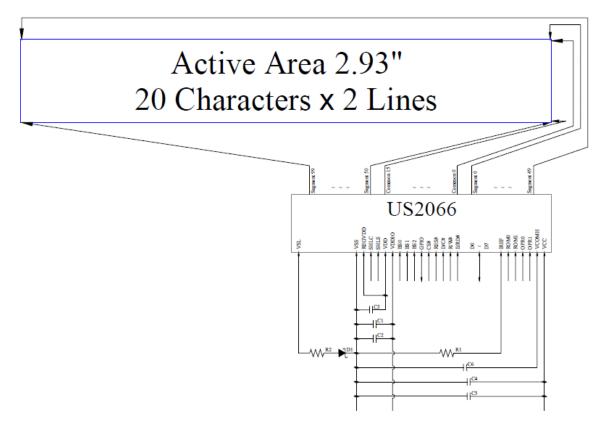
50Ω, 1/4W R2: ≤1.4V, 0.5W D1:

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## 3.4.2 5V I/O Application



MCU Interface Selection: BS0, BS1 and BS2

Pins connected to MCU interface: CS#, RES#, D/C#, R/W#, E/RD#, and D0~D7

\* SHLC, SHLC, ROM0, ROM1, OPR0 and OPR1 should be configured.

C1, C4: 0.1µF C2: 4.7µF

C3: 1µF C5: 10µF

C6: 4.7µF / 25V Tantalum Capacitor

R1:  $470k\Omega$ , R1 = (Voltage at IREF - VSS) / IREF

R2:  $50\Omega$ , 1/4W D1:  $\leq$ 1.4V, 0.5W

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## 3.5 TIMING CHARACTERISTICS

## 3.5.1 AC CHARACTERISTICS

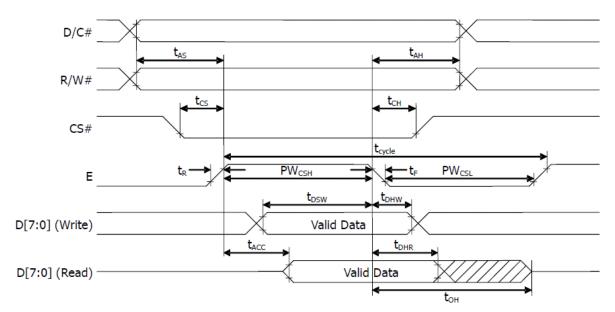
# 3.5.1.1 68XX-Series MPU Parallel Interface Timing Characteristics

Symbol	Description	Min	Max	Unit
tcycle	System Cycle Time	400	-	ns
$t_{AS}$	Address Setup Time	13	-	ns
$t_{AH}$	Address Hold Time	17	-	ns
$t_{DSW}$	Write Data Setup Time	35	-	ns
$t_{\mathrm{DHW}}$	Write Data Hold Time	18	-	ns
$t_{\mathrm{DHR}}$	Read Data Hold Time	13	-	ns
$t_{OH}$	Output Disable Time	10	90	ns
4	Access Time (RAM)		125	ns
$t_{ACC}$	Access Time (Command)	-		
$t_{CS}$	Chip Select Time	0	-	ns
$t_{CH}$	Chip Select Hold Time	0	-	ns
	Chip Select Low Pulse Width (Read RAM)	250		
$PW_{CSL}$	Chip Select Low Pulse Width (Read Command)	250	-	ns
	Low Pulse width (Write)	50		
DIII	Chip Select High Pulse Width (Read) Chip Select	155		ns
$PW_{CSH}$	High Pulse Width (Write)	55	-	
$t_R$	Rise Time	-	15	ns
$t_{\mathrm{F}}$	Fall Time	-	15	ns

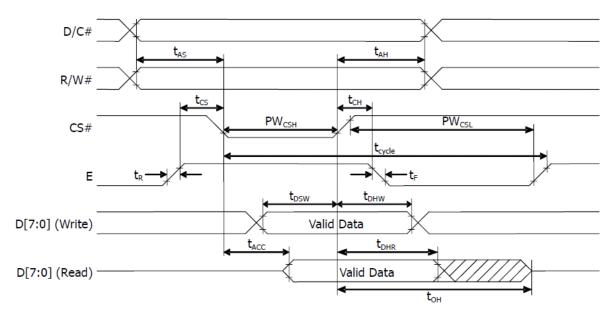
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( CS# "Low Pulse Width" > E "High Pulse Width" )



( CS# "Low Pulse Width" < E "High Pulse Width" )

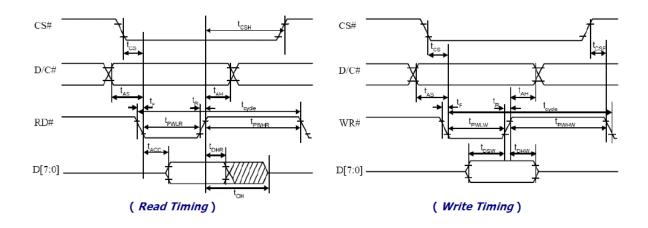
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# 3.5.1.2 8080-Series MPU Parallel Interface Timing Characteristics

Symbol	Description	Min	Max	Unit
tcycle	System Cycle Time	400	-	ns
t <sub>AS</sub>	Address Setup Time	13	-	ns
$t_{AH}$	Address Hold Time	17	-	ns
$t_{ m DSW}$	Write Data Setup Time	35	-	ns
$t_{\mathrm{DHW}}$	Write Data Hold Time	18	-	ns
$t_{\mathrm{DHR}}$	Read Data Hold Time	13	-	ns
t <sub>OH</sub>	Output Disable Time	10	70	ns
4	Access Time (RAM)		125	<b>n</b> c
$t_{ACC}$	Access Time (Command)		125	ns
$t_{CS}$	Chip Select Time	0	-	ns
$t_{CSH}$	Chip Select Hold Time to Read Signal	0	-	ns
$t_{CSF}$	Chip Select Hold Time	0	-	ns
	Chip Select Low Pulse Width (Read RAM)- t <sub>PWLR</sub>	250		
$PW_{CSL}$	Chip Select Low Pulse Width (Read Command)- t <sub>PWLR</sub>	250	-	ns
	Low Pulse width (Write)- t <sub>PWLW</sub>	50		
DW	Chip Select High Pulse Width (Read)- t <sub>PWHR</sub>	155	-	ns
$PW_{CSH}$	High Pulse Width (Write)- t <sub>PWHW</sub>	55		
$t_R$	Rise Time	-	15	ns
$t_{\mathrm{F}}$	Fall Time	1	15	ns



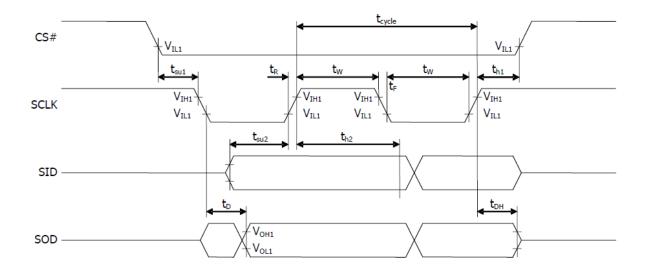
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# **3.5.1.3** Serial Interface Timing Characteristics

Symbol	Description	Min	Max	Unit
tcycle	Serial Clock Cycle Time	1	20	ns
$t_{su1}$	Chip Select Setup Time	60	-	ns
t <sub>h1</sub>	Chip Select Hold Time	20	-	ns
$t_{su2}$	Serial Input Data Setup Time	200	-	ns
$t_{h2}$	Serial Input Data Hold Time	TBD	-	ns
$t_{\mathrm{D}}$	Serial Output Data Delay Time	-	TBD	ns
$t_{\mathrm{DH}}$	Serial Output Data Hold Time	10	-	ns
$t_{ m W}$	Serial Clock Width (Low, High)	400	-	ns
$t_R$	Rise Time	-	15	ns
$t_{\mathrm{F}}$	Fall Time	-	15	ns



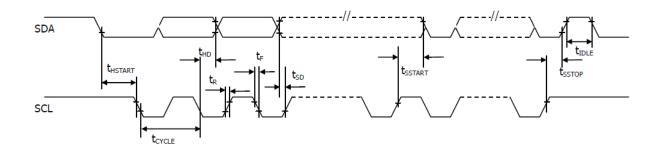
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# **3.5.1.4** I<sup>2</sup>C Interface Timing Characteristics

Symbol	Description	Min	Max	Unit
tcycle	Clock Cycle Time	2.5	-	us
t <sub>HSTART</sub>	Start Condition Hold Time	0.6	-	us
	Data Hold Time (for "SDAOUT" Pin) Data	5		
$t_{ m HD}$	Hold Time (for "SDAIN" Pin)	300	-	ns
$t_{\mathrm{SD}}$	Data Setup Time	100	-	ns
t <sub>SSTART</sub>	Start Condition Setup Time (Only relevant for a repeated Start condition)	0.6	-	us
$t_{SSTOP}$	Stop Condition Setup Time	0.6	-	us
$t_R$	Rise Time for Data and Clock Pin		300	ns
$t_{\mathrm{F}}$	Fall Time for Data and Clock Pin		300	ns
t <sub>IDLE</sub>	Idle Time before a New Transmission can Start	1.3	-	us



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# **4 OPTICAL SPECIFICATION**

# 4.1 OPTICAL CHARACTERISTICS

Characteristics	Symbol	Condition	Min	Тур	Max	Unit
Brightness	$L_{br}$	Note 1	100	120	-	cd/m <sup>2</sup>
C.I.E.(White)	(X)	CLE 1021	0.25	0.29	0.33	
	(Y)	C.I.E. 1931	0.27	0.31	0.35	-
Dark Room Contrast	CR		-	>10,000:1	-	-
Viewing Angle			-	Free	-	degree

Optical measurement taken at  $V_{DD} = 2.8V$  or 5.0V,  $V_{CC} = 12.0V$ .

Note 1 Brightness ( $L_{br}$ ) and Supply Voltage for Display ( $V_{CC}$ ) are subject to the change of the panel characteristics and the customers request

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Software configuration follows Section 5.4 Actual Application Example



## 5 FUNCTIONAL SPECIFICATION

### 5.1 COMMANDS

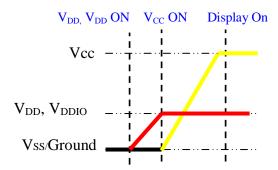
Please refer to the Technical Manual for the US2066

#### 5.2 POWER UP/DOWN SEQUENCE

To protect panel and extend the panel lifetime, the driver IC power up/down routine should include a delay period between high voltage and low voltage power sources during turn on/off. It gives the panel enough time to complete the action of charge and discharge before/after the operation.

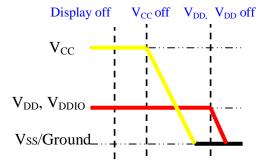
#### 5.2.1 POWER UP SEQUENCE

- 1. Power up  $V_{DD}$  and  $V_{DDIO}$
- 2. Send Display off command
- 3. Initialization
- 4. Clear Screen
- 5. Power up Vcc
- 6. Delay 100ms
- (When Vcc is stable)
- 7. Send Display on command



#### **5.2.2 POWER DOWN SEQUENCE**

- 1. Send Display off command
- 2. Power down V<sub>CC</sub>
- 3. Delay 100ms (When V<sub>cc</sub> reaches 0 and panel is Completely discharged)
- 4. Power down V<sub>DD</sub> and V<sub>DDIO</sub>



#### Conditions:

- 1) Since an ESD protection circuit is connected between VDD, VDDIO and VCC inside the driver IC, VCC becomes lower than VDD& VDDIO whenever VDD& VDDIO is ON and VCC is OFF.
- 2) VCC should be kept float (disable) when it is OFF.
- 3) Power Pins (VDD, VDDIO, VCC) can never be pulled to ground under any circumstance.
- 4) VDD&VDDIO should not be power down before VCC power down.

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## 5.3 RESET CIRCUIT

When RES# input is low, the chip is initialized with the following status:

- 1. Display is off
- 2. 5X8 Character Mode
- 3. Display start position is set at display RAM address 0
- 4. CGRAM address counter is set at 0
- 5. Cursor is OFF
- 6. Blink is OFF
- 7. Contrast control register is set at 7FH
- 8. OLED command set is disabled

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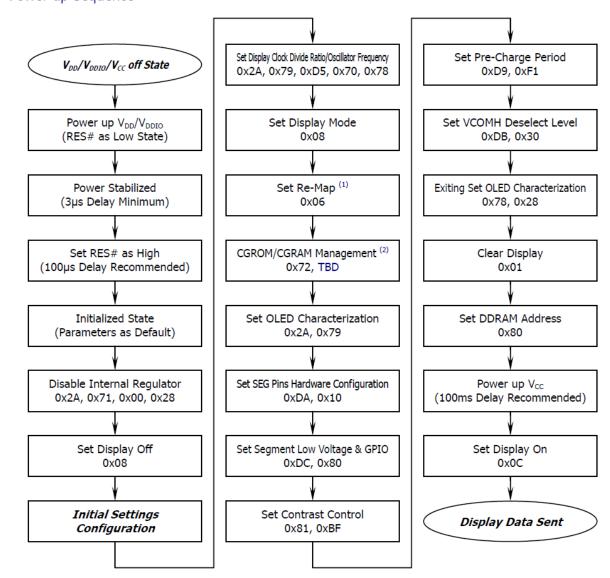


#### 5.4 ACTUAL APPLICATION EXAMPLE

Command usage and explanation of an actual example

# 5.4.1 Low Voltage I/O Application

<Power up Sequence>



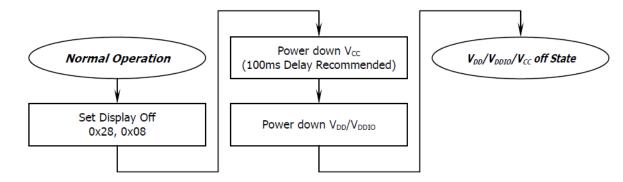
- (1) This command could be programmable or defined by pin configuration.
- (2) This command could be programmable or defined by pin configuration. The written value of the parameter should depend on the selection from section 5.5 and 5.6

If the noise is accidentally occurred at the displaying window during the operation, please reset the display in order to recover the display function.

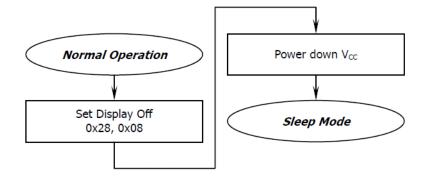
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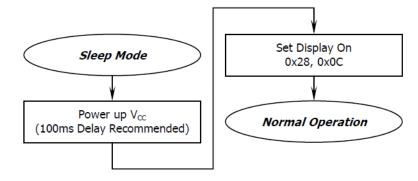
## <Power down Sequence>



# <Entering Sleep Mode>



## <Exiting Sleep Mode>



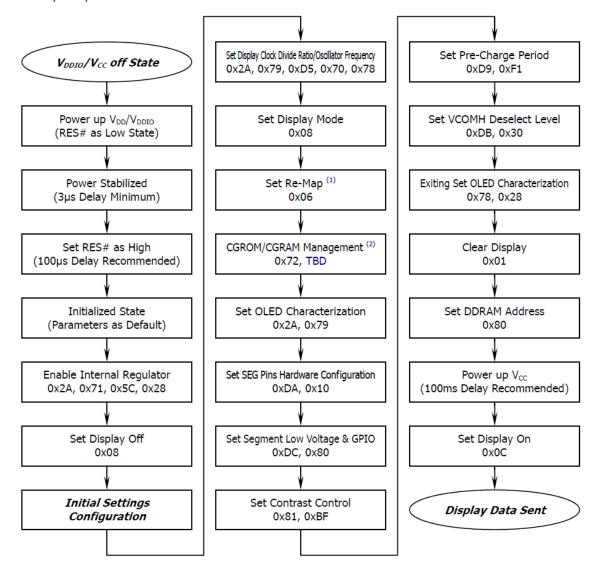
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## 5.4.2 5V I/O Application

<Power up Sequence>



- (1) This command could be programmable or defined by pin configuration.
- (2) This command could be programmable or defined by pin configuration. The written value of the parameter should depend on the selection from section 5.5 and 5.6

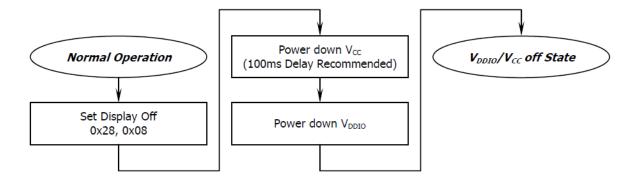
If the noise is accidentally occurred at the displaying window during the operation, please reset the display in order to recover the display function.

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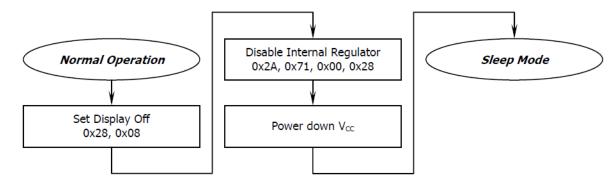
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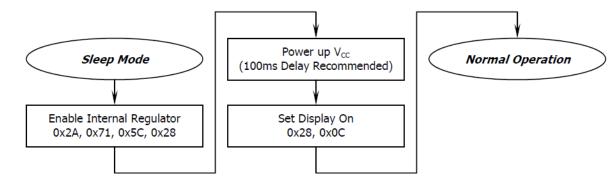
### <Power down Sequence>



## <Entering Sleep Mode>



## <Exiting Sleep Mode>



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# 5.5 BUILD-IN CGROM (CHARACTER GENERATOR ROM)

### 5.5.1 ROMA

Language: English, Irish, Spanish, Dutch (2), Danish, Norwegian, Swedish, Finnish, Czech (7), Slovene, Hungarian (2), Turkish (1)

The number in the parentheses is showing how many letters might be needed to build and define additionally at CGRAM. The darker background is showing the maximum addresses  $(00h\sim07h)$  those could be allocated by OPR[1:0] setting.

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### 5.5.2 **ROMB**

ROM	B (RC	DM[1:	0] = [	[0:1])												
63-0	0000	0001	0010	0011	0100	0101	0110	0111	1000	1001	1010	1011	1100	1101	1110	1111
0000				Z	Z					H	E C	8		3	E	Ħ
0001			H			K					3	Ħ		X	Ë	Ï
0010				×		超			ĸ	Ш	H			Ħ	Ë	Ħ
0011		법	Ш	g						ğ	Ħ	8	Ħ		莒	Ħ
0100					K	II	Z	Z	Ш		Ï			X	Ë	X
0101		쳟	Ž	Ø				K		2	Ħ	ŭ		Ħ	置	Ħ
0110		H	8	Ħ		Å		W	铅			X		Ħ		Ħ
0111								W			ä	X	X	Ž		
1000		*				2		羹	ı	Ш	Ë	N		Z	ä	8
1001					Ш	M		E	ĭ	Ш		H		I	ä	X
1010		×	W			•			8		Ħ	ĕ	Ä	Ľ		ľ
1011					2		B	H			H			Ħ	ä	Ħ
1100				8							ľ					
1101										E	ž			ŭ	B	E
1110				8	E	W	I			1	8		Ĭ	g		3
1111			M	Ħ	X			H		ğ	ă			E	Ö	Ë

Language: English, Irish, Portuguese, Spanish, French (1), Italian, German, Dutch (2), Icelandic, Danish, Norwegian, Swedish, Polish (8), Czech (8), Hungarian (2), Romanian (5), Turkish, Vietnamese (6), Russian (Small Letters)

The number in the parentheses is showing how many letters might be needed to build and define additionally at CGRAM. The darker background is showing the maximum addresses (00h~07h) those could be allocated by OPR[1:0] setting.

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#### 5.5.3 **ROMC**

Language: English, Dutch (2), Japanese, Greek (Small Letters)

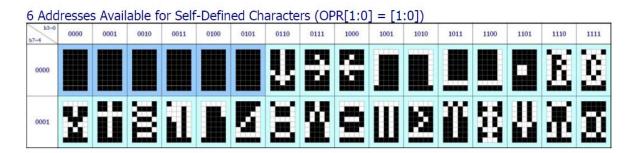
The number in the parentheses is showing how many letters might be needed to build and define additionally at CGRAM. The darker background is showing the maximum addresses (00h~07h) those could be allocated by OPR[1:0] setting.

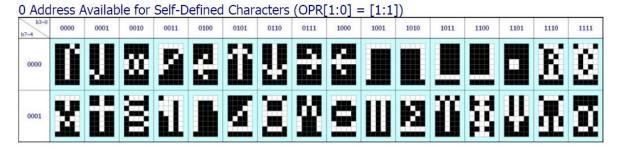
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# 5.6 SELF-DEFINED CGRAM (CHARACTER GENERATOR RAM)

7-4	0000	0001	0010	0011	0100	0101	0110	0111	1000	1001	1010	1011	1100	1101	1110	1111
0000																
0001	X	ü	Ħ			Œ	X	¥		Ш	18	II	は			



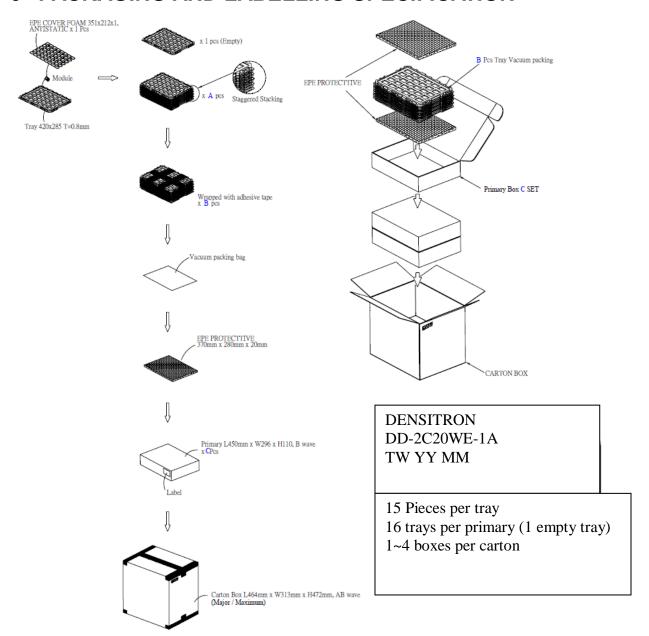


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# **6 PACKAGING AND LABELLING SPECIFICATION**



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## 7 QUALITY ASSURANCE SPECIFICATION

#### 7.1 CONFORMITY

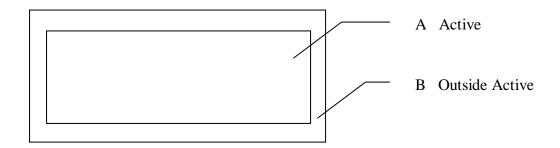
The performance, function and reliability of the shipped products conform to the Product Specification.

### 7.2 DELIVERY ASSURANCE

#### 7.2.1 DELIVERY INSPECTION STANDARDS

IPC-AA610, class 2 electronic assemblies standard

#### 7.2.2 Zone definition



#### 7.2.3 Visual inspection

Test and measurement to be conducted under following conditions:

Temperature:  $23\pm5^{\circ}\text{C}$ Humidity:  $55\pm15\%\text{RH}$ Fluorescent lamp: 30 W

Distance between the Panel & Eyes of the Inspector: ≥30cm

Distance between the Panel & the lamp: ≥50cm

Finger glove (or finger cover) must be worn by the inspector.

Inspection table or jig must be anti-electrostatic

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# 7.2.4 Standard of appearance inspection

Partition	AQL	Definition
Major	0.65	Defects in Pattern Check (Display On)
Minor	1.0	Defects in Cosmetic Check (Display Off)

Check Item	Classification	Criteria
Panel General Chipping	Minor	X > 6 mm (Along with Edge) Y > 1 mm (Perpendicular to edge)

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Check Item	Classification	Criteria
Panel Crack	Minor	Any crack is not allowable.
Cupper Exposed (Even Pin or Film)	Minor	Not Allowable by Naked Eye Inspection
Film or Trace Damage	Minor	
		Not Allowable
Terminal Lead Twist	Minor	D. TWISTED LEAD
Terminal Lead Broken	Minor	Not Allowable  A. BROKEN LEAD
Terminal Lead Prober Mark	Acceptable	

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Check Item	Classification	Criteria
Terminal Lead Bent	Minor	NG if any bent lead cause lead shorting.
(Not Twist or Broken)	Minor	NG for horizontally bent lead more than 50% of its width.
Glue or Contamination on Pin (Couldn't Be Removed by Alcohol)	Minor	
Ink Marking on Back Side of panel (Exclude on Film)	Acceptable	Ignore for Any

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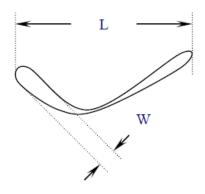
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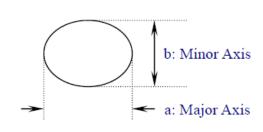


Check Item	Classification	Criteria
Any Dirt & Scratch on Polarizer's Protective Film	Acceptable	Ignore for not Affect the Polarizer
Scratches, Fiber, Line-Shape Defect (On Polarizer)	Minor	$\label{eq:weights} \begin{array}{ll} W \leq 0.1 & \text{Ignore} \\ W > 0.1,  L \leq 2 & n \leq 1 \\ L > 2 & n = 0 \end{array}$
Dirt, Black Spot, Foreign Material, (On Polarizer)	Minor	$\Phi \le 0.1$ Ignore $0.1 < \Phi \le 0.25$ $n \le 1$ $0.25 < \Phi$ $n = 0$
Dent, Bubbles, White spot (Any Transparent Spot on Polarizer)	Minor	Φ ≤ 0.5  → Ignore if no Influence on Display  0.5 < Φ
Fingerprint, Flow Mark (On Polarizer)	Minor	Not Allowable

- \* Protective film should not be tear off when cosmetic check.
- \*\* Definition of W & L &  $\Phi$  (Unit: mm):

$$\Phi = (a+b)/2$$





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Check Item	Classification	Criteria
No Display	Major	
Flicker	Major	Not Allowable
Missing Line	Major	
Pixel Short	Major	
Darker Pixel	Major	
Wrong Display	Major	
Un-uniform	Major	

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#### 7.3 DEALING WITH CUSTOMER COMPLAINTS

## 7.3.1 Non-conforming analysis

Purchaser should supply Densitron with detailed data of non-conforming sample. After accepting it, Densitron should complete the analysis in two weeks from receiving the sample.

If the analysis cannot be completed on time, Densitron must inform the purchaser.

# 7.3.2 Handling of non-conforming displays

If any non-conforming displays are found during customer acceptance inspection which Densitron is clearly responsible for, return them to Densitron.

Both Densitron and customer should analyse the reason and discuss the handling of non-conforming displays when the reason is not clear.

Equally, both sides should discuss and come to agreement for issues pertaining to modification of Densitron quality assurance standard.

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# **8 RELIABILITY SPECIFICATION**

## 8.1 RELIABILITY TESTS

Test Item	Test Condition	Evaluation and assessment	
High Temperature Operation	85°C, 240 hours	No abnormalities in function and appearance	
Low Temperature Operation	-40°C, 240 hours	No abnormalities in function and appearance	
High Temperature Storage	90°C, 240 hours	No abnormalities in function and appearance	
Low Temperature Storage	-40°C, 240 hours	No abnormalities in function and appearance	
High Temperature & High Humidity Storage	60°C, 90%RH, 240hours	No abnormalities in function and appearance	
Thermal Shock	-40°C ⇔ 85°C, 100 cycles. 60 Mins dwell	No abnormalities in function and appearance	

- The samples used for above tests do not include polarizer.
- No moisture condensation is observed during tests.

#### 8.1.1 FAILURE CHECK STANDARD

After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure teat at  $23\pm5$  °C;  $55\pm15\%$  RH

## 8.2 LIFE TIME

Item	Description
1	Function, performance, appearance, etc. shall be free from remarkable deterioration more than 30,000 hours under 120 cd/m² brightness and 50% Checkerboard, humidity (50% RH), and in area not exposed to direct sunlight. Vcc=12.0V, Ta=25°C, 50% Checkerboard. Software configuration follows Section 5.4 Initialization.
2	End of lifetime is specified as 50% of initial brightness. The average operating lifetime at room temperature is estimated by the accelerated operation at high temperature conditions.

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## 9 HANDLING PRECAUTIONS

#### 9.1 HANDLING PRECAUTIONS

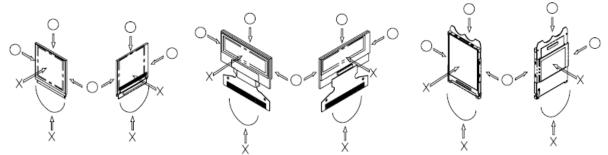
- 1) Since the display panel is being made of glass, do not apply mechanical impacts such us dropping from a high position.
- 2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- 3) If pressure is applied to the display surface or its neighborhood of the OEL display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
- 4) The polarizer covering the surface of the OEL display module is soft and easily scratched. Please be careful when handling the OEL display module.
- 5) When the surface of the polarizer of the OEL display module has soil, clean the surface. It takes advantage of by using following adhesion tape.
  - \* Scotch Mending Tape No. 810 or an equivalent

    Never try to breathe upon the soiled surface nor wipe the surface using cloth

containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy.

Also, pay attention that the following liquid and solvent may spoil the polarizer:

- \* Water
- \* Ketone
- \* Aromatic Solvents
- 6) Hold OEL display module very carefully when placing OEL display module into the system housing. Do not apply excessive stress or pressure to OEL display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.



- 7) Do not apply stress to the LSI chips and the surrounding molded sections.
- 8) Do not disassemble nor modify the OEL display module.
- 9) Do not apply input signals while the logic power is off.
- 10) Pay sufficient attention to the working environments when handing OEL display modules to prevent occurrence of element breakage accidents by static electricity.
  - \* Be sure to make human body grounding when handling OEL display modules.
  - \* Be sure to ground tools to use or assembly such as soldering irons.
  - \* To suppress generation of static electricity, avoid carrying out assembly work under dry environments.

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- \* Protective film is being applied to the surface of the display panel of the OEL display module. Be careful since static electricity may be generated when exfoliating the protective film.
- 11) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OEL display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5).
- 12) If electric current is applied when the OEL display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

#### 9.2 STORAGE PRECAUTIONS

- 1) When storing OEL display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps, etc. and, also, avoiding high temperature and high humidity environments or low temperature (less than 0°C) environments. (We recommend you to store these modules in the packaged state when they were shipped from Densitron Technologies Plc.) At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.
- 2) If electric current is applied when water drops are adhering to the surface of the OEL display module, when the OEL display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.

#### 9.3 DESIGNING PRECAUTIONS

- 1) The absolute maximum ratings are the ratings which cannot be exceeded for OEL display module, and if these values are exceeded, panel damage may be happen.
- 2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.
- 3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD). (Recommend value: 0.5A)
- 4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.
- 5) As for EMI, take necessary measures on the equipment side basically.
- 6) When fastening the OEL display module, fasten the external plastic housing section.
- 7) If power supply to the OEL display module is forcibly shut down by such errors as taking out the main battery while the OEL display panel is in operation, we cannot guarantee the quality of this OEL display module.
- 8) The electric potential to be connected to the rear face of the IC chip should be as follows: US2066
  - \* Connection (contact) to any other potential than the above may lead to rupture of the IC.

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## 9.4 OTHER PRECAUTIONS

- 1) When an OEL display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur. Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.
- 2) To protect OEL display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OEL display modules.
  - \* Pins and electrodes
  - \* Pattern layouts such as the FPC
- 3) With this OEL display module, the OEL driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this OEL driver is exposed to light, malfunctioning may occur.
  - \* Design the product and installation method so that the OEL driver may be shielded from light in actual usage.
  - \* Design the product and installation method so that the OEL driver may be shielded from light during the inspection processes.
- 4) Although this OEL display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.
- 5) We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.

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# 10 SUPPORTED ACCESSORIES

#### **10.1 DUO KIT**

Densitron has developed an easy to use yet powerful development and demonstration tool for driving its range of Passive Matrix OLED displays from the USB port of a PC.

DUO (Densitron USB OLED) kit is hot pluggable and does not require extra cables or power supply to run, allowing users to be up and running in minutes.

The kit consists of an OLED display with transition Board, USB controller card, mini USB cable and a CD with software application and drivers.



Part number: PDK-N-2C20WE-1A

#### 10.1 TRANSITION BOARD CARD

A Transition board card is like a daughterboard which is meant to be a circuit board for connections between the baseboards (DUO).

It has connector pins for interfacing between the display and the baseboards.

It also includes the OLED display. **Part number: PDT-N-2C20WE-1A** 

#### 10.2 CONNECTOR BOARD CARD

A Connector board card is also a daughterboard which is a circuit board for connection between a microprocessor or microcontroller (customer's system).

Part number: EVK-CONNECT-029

#### 10.3 CONNECTOR

Type: hot bar soldering process

No. of connections: 33

Pitch: 0.70mm

### 10.4 APPLICATION NOTES AND EXAMPLE CODES

#### On request to Densitron

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